SURYAANSH RATHINAM

suryaansh2002@gmail.com | +6582782863| +919619514015 | Portfolio | Linkedin | Github | Leetcode

PROFESSIONAL SUMMARY

Full-stack developer and AI specialist with a passion for building intelligent, scalable applications using modern web frameworks and cloud technologies. Strong expertise in implementing production-level AI solutions including LLMs and computer vision systems, with comprehensive knowledge across the development stack from frontend and backend frameworks to distributed systems.

EDUCATION

National University of Singapore

Aug 2024 - Dec 2025

Masters of Computing (AI Specialization)

GPA: 4.63 / 5

- Coursework: Neural Networks and Deep Learning, AI Planning and Decision Making, Distributed Systems, Knowledge Discovery and Data Mining, Big Data Analytics Technology, Uncertainty Modelling in AI, Text Mining.
- Teaching Assistant: Cloud Computing

Manipal Institute of Technology

Sep 2020 - Jul 2024

BTech, Computer Science Engineering

GPA: 9.47 / 10

SKILLS

- <u>Programming Languages</u>: Python, C, C++, Java, JavaScript, Typescript
- Full-stack Development: React, Next, Vue, Angular, Node, Express, Nest, PHP, Django, FastAPI.
- Database Systems: MongoDB, MySQL, Redis, Postgres, TypeORM
- Cloud and Devops: AWS, Firebase, Git, Docker, GCP
- Others: Selenium, Appium, Excel

WORK EXPERIENCE

Asian Institute of Digital Finance – Research Assistant

Oct 2024 - Present

• Working as a Full stack developer, on building 'Caesers' a platform for generating Credit Risk Assessment Reports leveraging Open AI's LLM, using **Django** for server and the **NextJS** for the client side of the application.

Moneyflo - Full Stack Developer

Mar 2023 - Jun 2024

- Implemented an **AI assistant** using OpenAI's GPT-40 model, seamlessly integrated into a dashboard, enabling clients to effortlessly extract deeper insights from data and make informed decisions increasing time spent using product by 25%.
- Utilized NextJS, Firebase on client side and utilized **NestJS**, **FastAPI** to build endpoints for application and **AWS S3**, **Lamba** and **EC2** were leveraged, to store and process large quantities of client data.

Indian Institute of Technology, Kharagpur - Research Intern

Jun 2023 - Aug 2023

Developed and fine-tuned a pre-trained U-Net model for image segmentation, further trained on 300 ultrasound images, after cleaning and pre-processing data, and fine tuning the model to obtain an accuracy of 99.2% for classification and identification of different regions of the kidney.

Ridecell - Software Engineering Intern

May 2022 - Aug 2022

• Employed in **QA** and automation team to test and debug API endpoints and mobile applications using **Python**, **Selenium**, **Pytest**, and **Appium**, managed test cases efficiently with **TestRail**.

PROJECTS

Distributed Maze Runner: A Fault-Tolerant Peer-to-Peer Game System (Link)

Sep-Oct 2024

Implemented **multi-threaded** server logic with dynamic server swapping for continuous operation, handling player crashes and asynchronous movements. Used **TCP/Java RMI** for reliable messaging and constructed a tracker-based player registry to enhance peer discovery and reduce system load, demonstrating fault-tolerance in gaming.

Manipal Institute of Technology (Link)

Aug- Oct 202

Built a **web-scraping and automation** tool using **Selenium** and **Python** automating the process of data collection and formatting it in the required format from the university portal, earlier done manually by professors, it is now done using software by 200+ faculty across university, reducing time taken for the task by more than **90%**.

PUBLICATIONS

- Exploring IoT-Blockchain Integration in Agriculture: An Experimental Study Published in IEEE Access (<u>Link</u>)
- Survey of the use of AI models and techniques in the analysis and prediction of neuro-degenerative diseases- Presented at AICECS 2023 and Published in IOP: Journal of Physics (Volume 2751) (<u>Link</u>)
- Analysis and Comparison of Different Frontend Frameworks- Presented at ATIS 2022 and Published in Springer's CCIS Series (Volume 1804) (<u>Link</u>)